

Intel **Developer** Forum



Converging Technologies:

Innovations in Computing and Communications

Welcome to the
Intel Developer Forum
Fall 2003

Pat Gelsinger
Senior Vice President and
Chief Technology Officer



Keynotes

OPENING DAY

Tuesday

Paul Otellini
Opening Keynote

Louis Burns
The Digital Home
Vision
and Direction

DAY 2

Wednesday

Anand Chandrasekher
Ron Smith
Mobility

Sandra Morris
Mike Fister
Enterprise Innovations

DAY 3

Thursday

Eric Mentzer
Communications
Infrastructure

Pat Gelsinger
Research and
Development

Intel Developer Forums for Fall 2003

A Worldwide Industry Event



USA
San Jose
9/16-18

RUSSIA
Moscow
10/28-29

PRC
Shenzhen
10/30-31

INDIA
Mumbai
10/21-22

TAIWAN
Taipei
10/13-14

Attend a Fall IDF Conference!
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Plan on Being Part of Spring IDF 2004 !

Announcing Spring 2004 IDF World Forums:

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- **San Francisco, California** February 17–20
 - **Tokyo, Japan** April 6–8
 - **Taipei, Taiwan** April 12–13
 - **Beijing, PRC** April 15–16
 - **Bangalore, India** April 20–21
 - **Western Europe** Late April

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invent

Building Blocks for
the Digital Home

TCG

High Performance Computing

D-Link
Building Networks for People

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ated Technology	Catalyst Enterprises, Inc.	EVERCASE	Intel Corporation - Platform Architecture Solutions Division	Mellanox Technologies Inc.	Promise Technology, Inc.	Thermacore International, Inc.
ed Systems of Mentor	CATC - Computer Access Technology Corporation	FCI Electronics	Intel Corporation - Intel(R) Developer Network for the Digital Home	mental images	Qlogic Corporation	TimeSys Corp.
s, Inc.	Celestica Inc.	Fibre Channel /Functionality at the Ultra 160 SCSI Price Functionality at the Ultra 160 SCSI Price	Intel® Developer Network for PCI Express* Architecture	Mentor Graphics	RadiSys Corp.	Trenton Technolo
, Inc.	Celestica Inc. (HPC)	Force Computers, Inc.	Intel® Enterprise Platforms & Services Division	Metrowerks	Reed Electronic Group	Trusted Computi Group
ining, Inc.	Chaun Choung Technology Corp. (CCI)	Furukawa America , Inc.	Intel® PCI Express* Products	Microsoft Corporation	Sandia National Laboratories	Tyan Computer
ed Industrial er, Inc.	Chroma ATE, INC.	Gateway, Inc.	Intel® PRO Gigabit Ethernet Controllers	Mindshare, Inc.	Sanyo Video Components	Tyco Electronics
Technologies	Ci Design	GDA Technologies Inc.	Intel's KAI Software Lab	Molex	Serial ATA Work Group II	Unisys Corporati
Technologies (PCI-	Ciara Technologies Inc. (HPC)	Genesys Logic	Interconnect Systems, Inc. (ISI)	MSI Computer Corp.	SigmaTel, Inc.	UPnP™ Implemen Corporation
oration	Ciara Technologies Inc. (Modular)	GigaCase Corp. (Yeong Yang US)	Interlink Networks	M-Systems Flash Disk Pioneers	Silicon & Software Systems Ltd.	USB Implementer Forum
Systems	Cirrus Logic, Inc.	Green Hills(r) Software, Inc.	International Rectifier	Fortress Security Division	Silicon Image, Inc.	VERITAS Softwar
n Arium	Cloakware Corporation	Hewlett-Packard Company (TCG)	Internet Machines Corp.	National Semiconductor	Silicon Mechanic, Inc.	VIA Technologies
n Megatrends Inc.	Compunetics Inc.	Hirose Electric Corp.	Intersil Corporation	National Semiconductor (TCG)	Silicon Semiconductor Corporation	Vishay Intertechn Inc.
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a Limited	Cornell Theory Center (CTC)	IBM (TCG)	Isola Laminate Systems Corp.	NEC TOKIN	Softex Incorporated	Vitesse (ICA)
igital Inc.	Crystal Group Inc.	IBM* DB2* Integrated Cluster Environment	Kontron	NetChip Technology, Inc.	Softex Incorporated (TCG)	VMETRO
Components, Inc.	Cypress Semiconductor Corp.	iCube	Lanner Electronics Inc.	nSys (Netsys Software Pvt. Ltd.)	Solid Information Technology	Wasabi Systems
al Components Co.,	Data Transit Corporation (PCI-Express)	IEEE Computer Society	Lawrence Livermore National Laboratory	NTRU	Sophia Systems Co. Ltd.	Wave Systems Co
orporation	Data Transit Corporation (Serial ATA)	IEEE Spectrum Magazine/IEEE Media	LeCroy Corporation	NVIDIA	Sparkle Power Inc.	Wind River
stems, Inc.	DataCore Software Corporation	ImpactXoft	Legend Group Ltd.	On Semiconductor	StarGen, Inc	Xilinx, Inc.
ftware, Inc.	Delta Products Corp / Components Products	Infinion Technologies (TCG)	Linux Magazine	Oregon Networks Ltd	STMicroelectronics, Inc.	ZettaCom, Inc.
o AG	Delta Products Corporation / Power Supply Products	Instant802 Networks, Inc	LSI Logic Corporation	Panasonic Industrial Company (Power Management)	STMicroelectronics, Inc. (ITS)	ZIPPY USA, INC.
e Design Systems,	Denali Software, Inc.	Insyde Software Corp.	LSI Logic Corporation (PCI-Express)	Panasonic Industrial Company (Thermal Solutions)	Sunon Inc.	
)	Digital 5, Inc.	Integrated Device Technology (IDT)	Macraigor Systems, LLC.	Park/Nelco	Super Micro Computer, Inc.	
Design Systems, -Express)	Digital Home Working Group	Intel Corporation - Modular Computing Community Info Kiosk	Marvell®	PCI-SIG®: PCI Express™	Synopsys, Inc.	
a Digital tion	Eastman Kodak Company, Display Group			PCI-SIG®: PCI-X® 2.0	SynQor, Inc.	
ntel	Electro Scientific Industries Inc. (ESI)			PCMCIA	TDK Corporation of America	
				PFU Systems HQ	Teja Technologies, Inc.	
				Pinnacle Data Systems, Incorporated.	Tektronix Inc.	
					TestQuest	

Chief Technology Officer Panel

Accelerating the Deployment of Disruptive Technologies: Steering Past the Speed Bumps

Host: Pat Gelsinger

Senior Vice President and Chief Technology Officer,
Intel Corporation

Moderator: Henry Chesbrough

Executive Director, Center for Technology Strategy and
Management, University of California, Berkeley, Walter A.
Haas School of Business

Panel Members:

Judy Estrin

Chief Executive Officer,
Packet Design

Robert Morris

Vice President and Director of Almaden Research Center,
IBM Research

Greg Papadopoulos

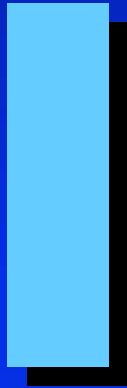
Senior Vice President and Chief Technology Officer,
Sun Microsystems

James D. Schlichting

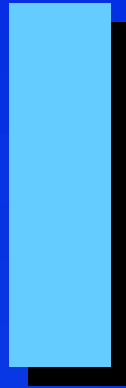
Deputy Chief, Office Of Engineering And Technology
Federal Communications Commission, Washington D. C.

Thursday, September 18 - 12:00pm–1:30pm
SJCC, Hall 2, Exhibit Level

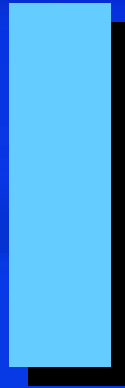
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Innovate

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